



32-bit MCUs

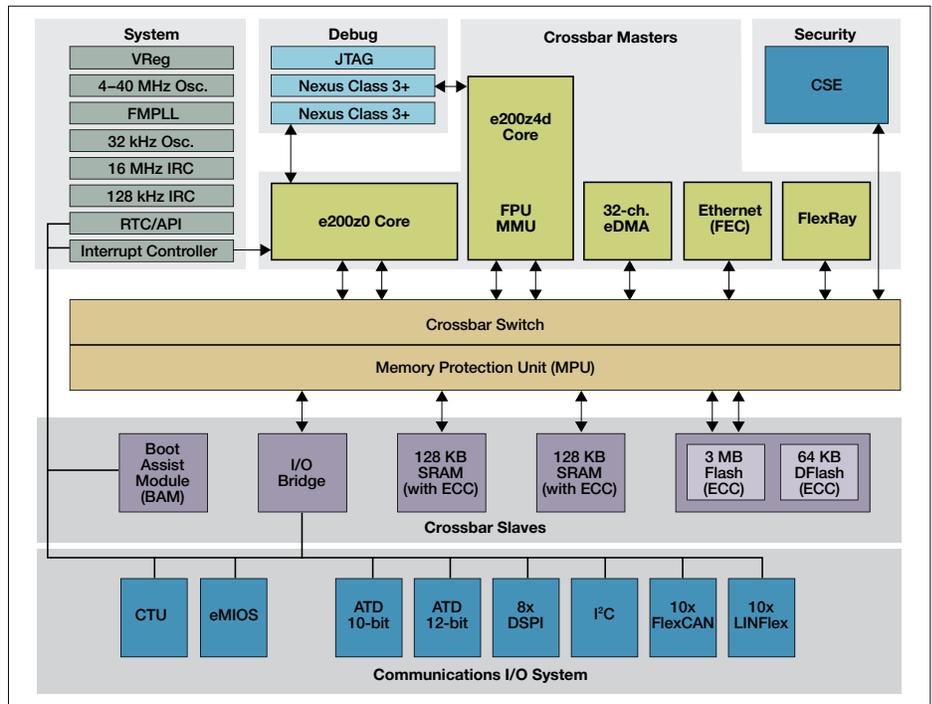
Qorivva MPC564xB/C Family

Secure automotive body and gateway applications

Overview

The Qorivva MPC564xB/C family of 32-bit MCUs is designed for secure, next-generation, high-end automotive body control module (BCM) and gateway applications. It offers a superior level of integration to address the growing need for enhanced feature sets and increased memory space of EOM and tier 1 networks. From a security standpoint, the MPC564xB/C includes an innovative cryptographic security engine (CSE)—a set of cryptographic hardware features that allow the transmission of information in a secure and trusted manner between parties. The MPC564xB/C family also features dual Power Architecture® core options for nearly 300 DMIPs of processing capability, low-power standby/wait modes to aid in reduced power consumption and a wide communications peripheral set offering to address the range of subsystems that interface with a BCM/gateway module. These scalable devices are supported by an enablement ecosystem that includes software drivers, operating systems and configuration code for quick design implementation.

Qorivva MPC564xB/C Block Diagram



256 BGA
17 mm x 17 mm
1 mm pitch



208 LQFP
28 mm x 28 mm
.5 mm pitch



176 LQFP
24 mm x 24 mm
.5 mm pitch



Applications

- High-end body control modules
- Automotive gateway controllers

Qorivva MPC564xB/C

Key Features

- The CSE hardware module is used to encode and decode data in a secure and reliable manner. Many body control modules on the market support security through software encryption capabilities. The MPC564xB/C offers this unique CSE module to move the control of cryptographic keys from the software domain to the hardware domain and significantly reduce security risks. The CSE module helps protect the security keys from software attack, provides an authentic software environment and allows for distributed key ownership. This enhanced security is ideal for a range of BCM/gateway use cases,

such as immobilizers, component protection, secure flash updates, protecting data sets (mileage), digital rights management, secure communication and IP protection.

- Dual-core options feature e200z4 and e200z0 cores for maximum performance and optimal power management through use of the secondary core as an I/O manager. The e200z4 core offers up to 120 MHz of performance and the e200z0 offers up to 80 MHz.
- 3 MB of flash and 256 KB of RAM, both of which include error code correction, efficiently manage message handling and autocoding requirements.
- Optimization for communication data management:
 - Ethernet and FlexRay supporting high-speed flash programming, vehicle diagnostics and safety/chassis network interfacing
 - FlexCAN module supporting both FIFO and mailbox data storage, ideal for CAN gateways to manage event-driven vs. periodic bus traffic
 - LINFlex module providing fully automated LIN message management, reducing CPU load intervention and message latencies
- eMIOS timer combines multiple counter sources, including input capture, output compare and pulse width modulation (PWM) capabilities into one very flexible module. PWM function supports shifted signal output to improve electromagnetic compatibility.
- Cross triggering unit (CTU) synchronizes PWM output signals with analog-to-digital conversion and control capabilities.
- Offers scalability and pin and software compatibility with the MPC560xB/C family of products.

Selector Guide

| Product Number | Core(s) | Flash | RAM | CSE | FlexRay | Ethernet | LINFlex | SPI | FlexCAN | Packages | Temp. Range |
|----------------|-------------------|--------|--------|----------|---------|----------|---------|-----|---------|--------------------------|-------------------|
| MPC5646C | e200z4+ e200z0 | 3 MB | 256 KB | Optional | Yes | Yes | 10 | 8 | 6 | 176/208 LQFP, 256 BGA | -40 °C to +125 °C |
| MPC5646B | e200z4 | 3 MB | 192 KB | Optional | Yes | No | 10 | 8 | 6 | 176/208 LQFP | -40 °C to +125 °C |
| MPC5645C | e200z4+ e200z0 | 2 MB | 256 KB | Optional | Yes | Yes | 10 | 8 | 6 | 176/208 LQFP, 256 BGA | -40 °C to +125 °C |
| MPC5645B | e200z4 | 2 MB | 160 KB | Optional | Yes | No | 10 | 8 | 6 | 176/208 LQFP | -40 °C to +125 °C |
| MPC5644C | e200z4+ e200z0 | 1.5 MB | 192 KB | Optional | Yes | Yes | 10 | 8 | 6 | 176/208 LQFP, 256 BGA | -40 °C to +125 °C |
| MPC5644B | e200z4 | 1.5 MB | 128 KB | Optional | Yes | No | 10 | 8 | 6 | 176/208 LQFP | -40 °C to +125 °C |

Development Tools

| Part Number | Description | Pricing* |
|-----------------|-----------------------------------|----------|
| XPC56XXMB2 | Development Motherboard | \$375 |
| XDC564B256BSB3M | 256 MAPBGA Socketed Daughter Card | \$120 |
| XDC564B208QSB3M | 208 LQFP Socketed Daughter Card | \$120 |
| XDC564B176QSB3M | 176 LQFP Socketed Daughter Card | \$120 |
| XKT564B176QSB3M | 176 LQFP Socket | \$497 |
| XKT564B208QSB3M | 208 LQFP Socket | \$497 |
| XKT564B256BSB3M | 256 BGA Socket | \$497 |

*Manufacturer Suggested Resale Price

For more information on Qorivva MPC564xB/C family solutions, visit freescale.com/Qorivva

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